T-1 3/4 (5mm) BI-COLOR RIGHT ANGLE LED INDICATOR

Part Number: WP150A9VS/EGW

High Efficiency Red Green

Features

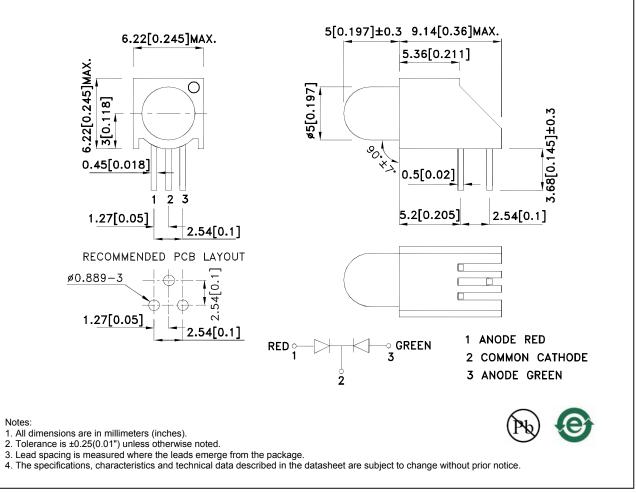
- Pre-trimmed leads for pc board mounting.
- High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



REV NO: V.4 CHECKED: Allen Liu DATE: APR/07/2011 DRAWN: J.Yu PAGE: 1 OF 6 ERP: 1102006958

Selection Guide	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
i ultitoi			Min.	Тур.	201/2
WP150A9VS/EGW	High Efficiency Red (GaAsP/GaP)	Mikita Diffused	18	50	- 30°
	Green (GaP)	White Diffused	18	50	

Notes: 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Green	627 565		nm	I⊧=20mA
λD [1]	Dominant Wavelength	High Efficiency Red Green	625 568		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Green	45 30		nm	I⊧=20mA
С	Capacitance	High Efficiency Red Green	15 15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	High Efficiency Red Green	2 2.2	2.5 2.5	V	I⊧=20mA
lr	Reverse Current	High Efficiency Red Green		10 10	uA	VR = 5V

Notes:

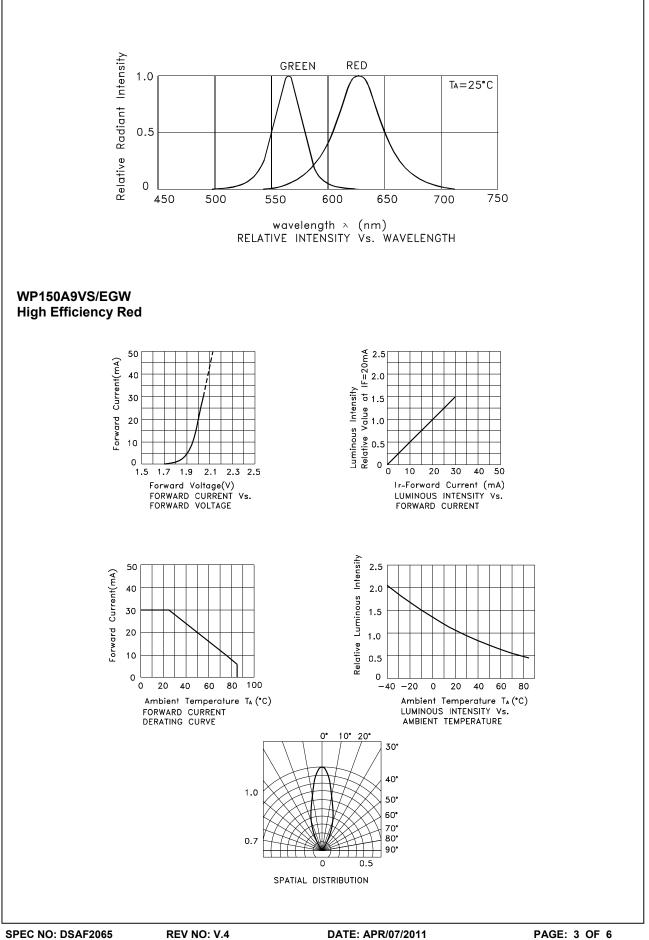
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

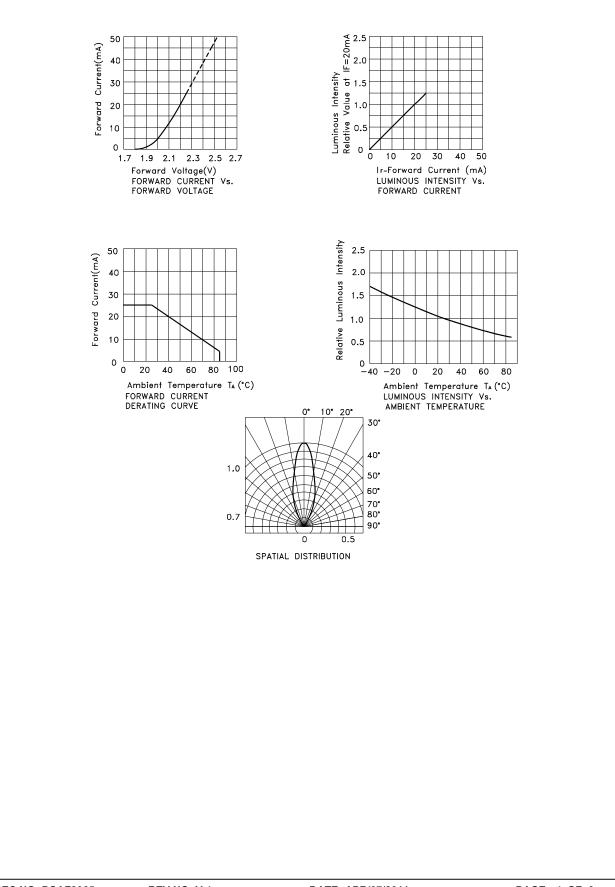
High Efficiency Red	Green	Units		
75	62.5	mW		
30	25	mA		
160	140	mA		
	V			
-40°C To +85°C				
260°C For 3 Seconds				
260°C For 5 Seconds				
	75 30 160	75 62.5 30 25 160 140 5 -40°C To +85°C 260°C For 3 Seconds		

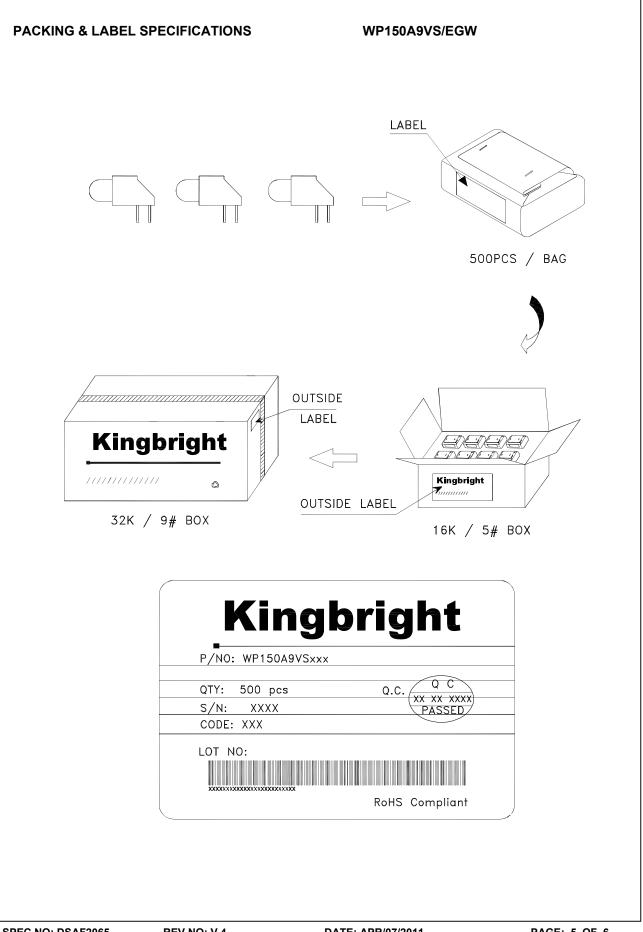
Notes

1.1/10 Duty Cycle, 0.1ms Pulse Width.
2.2mm below package base.
3.5mm below package base.



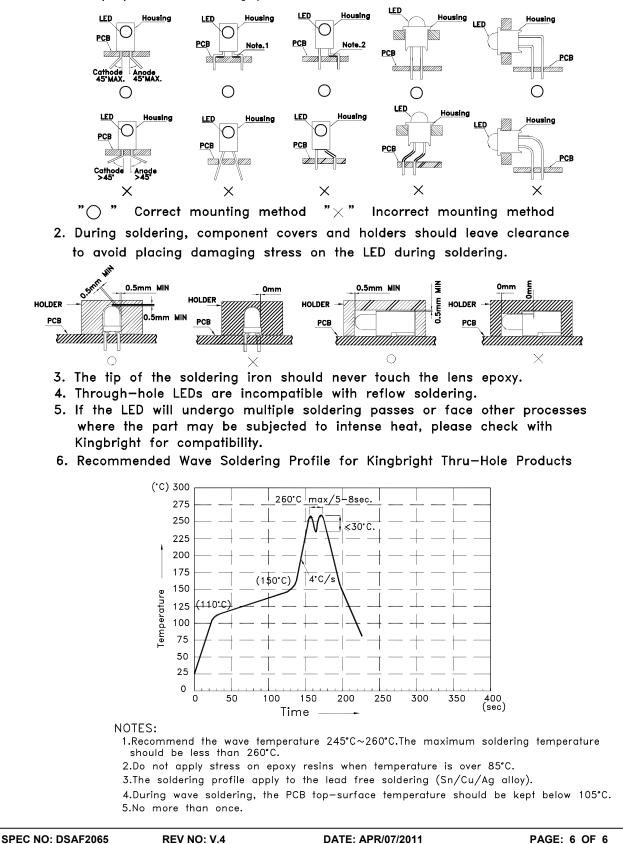
Green





PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



DATE: APR/07/2011 DRAWN: J.Yu